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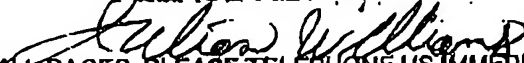
15 MAY 2007

FILE #: 09852/0205523-030Legal Staff
International DivisionDATE: 5/15/07NUMBER TRANSMITTING TO: 571-273-0459RECIPIENT: PCT Legal DeptCOMPANY: Patent & Trademarks OfficeFROM: F Lynn BarrisonNO. OF PAGES TRANSMITTING
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Customer No.: 07278

Docket No.: 09852/0205523-US0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Hideki Fujiwara et. al.

Serial No.: 10/599,440

Filed: September 28, 2006

For: SILICON ELECTRODE PLATE FOR PLASMA ETCHING WITH SUPERIOR DURABILITY

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner of Patents and Trademarks
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

1. Attached is a copy of the official filing receipt received from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested.
2. There is an error with respect to the following data, which is:

- ☒ incorrectly entered and/or
☐ omitted.

Correct data

Hideki Fujiwara, Tokyo, Japan
Kazuhiro Ikezawa, Tokyo, Japan
Hiroaki Taguchi, Tokyo, Japan
Naofumi Iwamoto, Takarazuki-shi, Japan
Toshinori Ishii, Osaka, Japan
Takashi Komekyu, Sanda-shi, Japan



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APPL NO.	FILING OR 371(c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	TOT CLMS	IND CLMS
10/599,440	09/28/2006	1751	900	09852/0205523-US0	1	1

CONFIRMATION NO. 8901

7278
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 NEW YORK, NY 10150-5257

FILING RECEIPT



OC000000023584608

Date Mailed: 05/03/2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt Incorporating the requested corrections (if appropriate).

Applicant(s)

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 Kazuhiro Ikezawa, Tokyo, JAPAN;
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Assignment For Published Patent Application

SUMCO CORPORATION, Tokyo, JAPAN
 Mitsubishi Materials Corporation, Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 7278.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP05/06134 03/30/2005

Foreign Applications

JAPAN 2004-108731 04/01/2004
 JAPAN 2004-234961 08/12/2004

Country JP
 D JP
 L JP
 FO JP
 Card JP
 J JP

If Required, Foreign Filing License Granted: 04/27/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/599,440**

Projected Publication Date: 08/09/2007

Non-Publication Request: No

Early Publication Request: No

Title

Silicon electrode plate for plasma etching with superior durability

Preliminary Class

510

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Application Data Sheet**Application Information**

Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	SILICON ELECTRODE PLATE FOR PLASMA ETCHING WITH SUPERIOR DURABILITY (AS AMENDED)
Attorney Docket Number::	09852/0205523-US0
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	Fig. 1
Total Drawing Sheets::	1
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

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Correspondence Customer Number:: 07278

Representative Information

Representative Customer Number:: 07278

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2005/006134	03/30/05

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-108731	04/01/04	Yes
Japan	2004-234961	08/12/04	Yes

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